

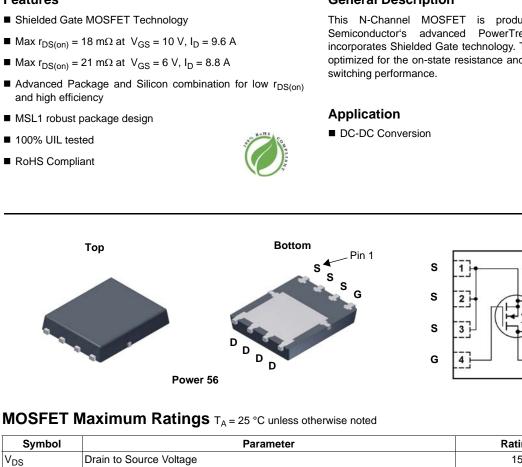
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Ratings Units 150 Drain to Source Voltage  $V_{GS}$ Gate to Source Voltage ±20 Drain Current -Continuous  $T_C = 25 \ ^{\circ}C$ 35 T<sub>A</sub> = 25 °C -Continuous (Note 1a) 9.6 -Pulsed 100 Single Pulse Avalanche Energy 220 EAS (Note 3) m.J  $T_C = 25 \degree C$ Power Dissipation 104 IP<sub>D</sub> Power Dissipation T<sub>A</sub> = 25 °C 2.5 (Note 1a) Operating and Storage Junction Temperature Range -55 to +150 °C T<sub>J</sub>, T<sub>STG</sub> **Thermal Characteristics** Thermal Resistance, Junction to Case  $R_{\theta JC}$ 1.2 °C/W Thermal Resistance, Junction to Ambient

# **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86200	FDMS86200	Power 56	13 "	12 mm	3000 units

(Note 1a)

50

 $I_D$ 

 $R_{\theta JA}$ 

# **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior

# **FDMS86200** N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET **150 V, 35 A, 18 m**Ω

# Features

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# FDMS86200 N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET

October 2014

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D

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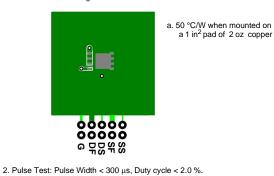
V

V

Α

W

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, V_{GS} = 0 \ V$	150			V	
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		110		mV/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 120 V, V <sub>GS</sub> = 0 V			1	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA	
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2.0	2.5	4.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-10		mV/°C	
r <sub>DS(on)</sub> Sta		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 9.6 A		15	18	-	
	Static Drain to Source On Resistance	$V_{GS} = 6 V, I_D = 8.8 A$		17	21		
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 9.6 A, T <sub>J</sub> = 125 °C		28	34		
9 <sub>FS</sub>	Forward Transconductance	V <sub>DD</sub> = 10 V, I <sub>D</sub> = 9.6 A		33		S	
Dynamic	Characteristics						
C <sub>iss</sub>	Input Capacitance	X 75 X X 0 X		2041	2715	pF	
C <sub>oss</sub>	Output Capacitance	─ V <sub>DS</sub> = 75 V, V <sub>GS</sub> = 0 V, f = 1 MHz		203	270	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			10	16	pF	
Rg	Gate Resistance			1.2	3	Ω	
Switching	g Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time			13	23	ns	
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 75 V, I <sub>D</sub> = 9.6 A,		7.9	16	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		27	44	ns	
t <sub>f</sub>	Fall Time	-		5.8	12	ns	
	Total Gate Charge	$V_{GS} = 0 V$ to 10 V		33	46	nC	
Q <sub>g(TOT)</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V V_{DD} = 75 V$		18	26	nC	
Q <sub>gs</sub>	Total Gate Charge	I <sub>D</sub> = 9.6 A		7.9		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			7.7		nC	
Drain-Sou	urce Diode Characteristics						
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.69	1.2	- V	
		$V_{GS} = 0 V, I_S = 9.6 A$ (Note 2)		0.77	1.3		
t <sub>rr</sub>	Reverse Recovery Time			76	120	ns	
Q <sub>rr</sub>	Reverse Recovery Charge	— I <sub>F</sub> = 9.6 A, di/dt = 100 A/μs		113	181	nC	



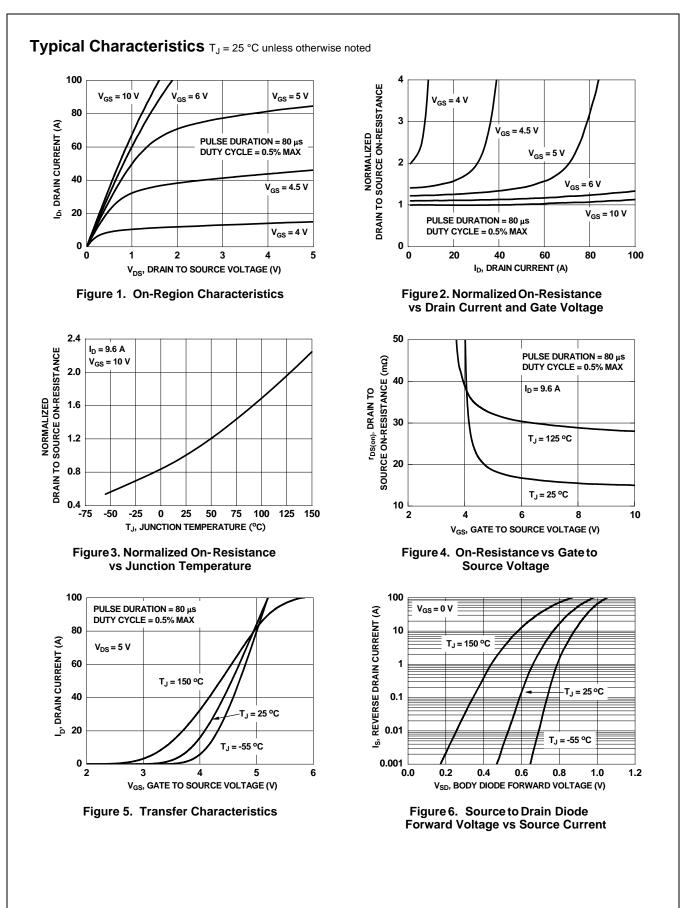
b.125 °C/W when mounted on a minimum pad of 2 oz copper

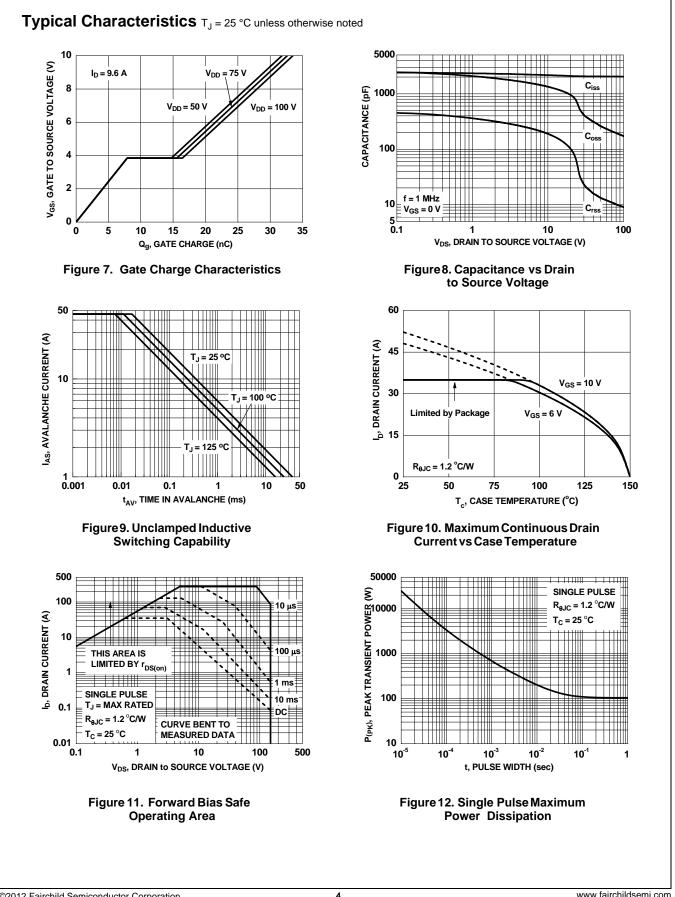
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00000 00 250 25 00 00 25 00 FDMS86200 N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET

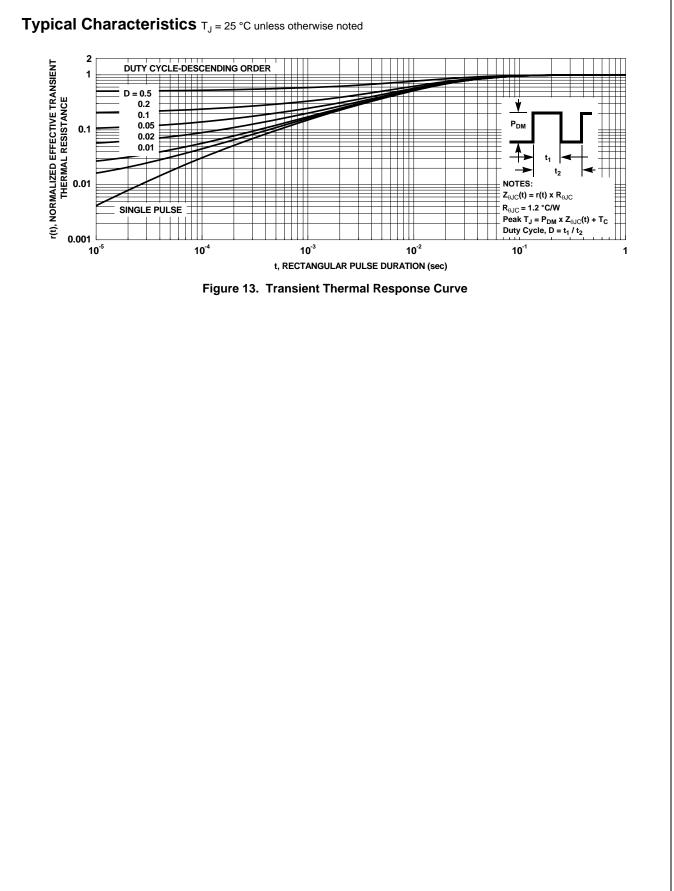
3.  $E_{AS}$  of 220 mJ is based on starting  $T_J$  = 25 °C, L = 1 mH,  $I_{AS}$  = 21 A,  $V_{DD}$  = 150 V,  $V_{GS}$  = 10 V. 100% test at L = 0.1 mH,  $I_{AS}$  = 46 A.



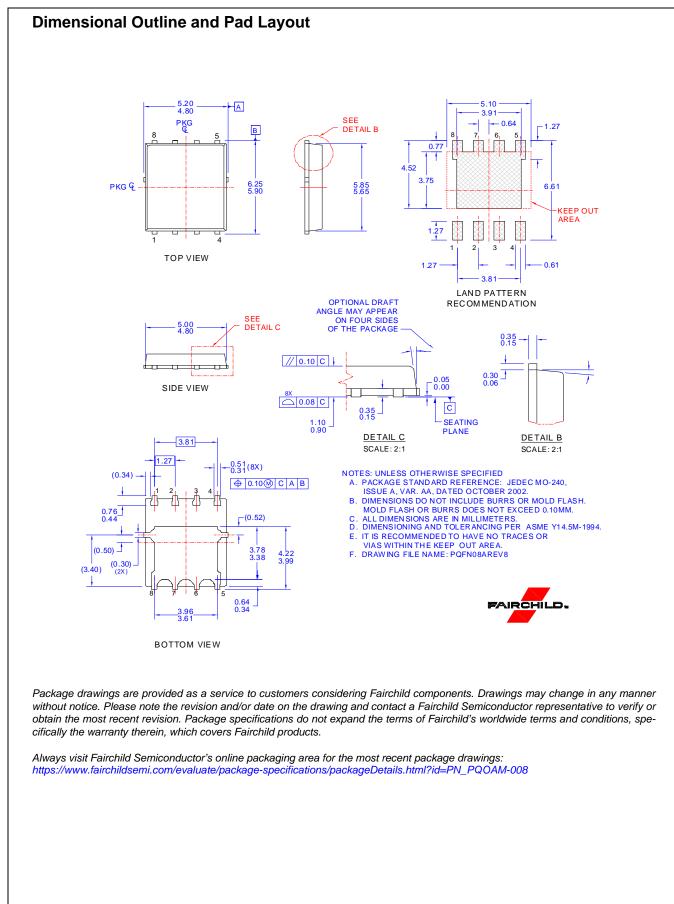




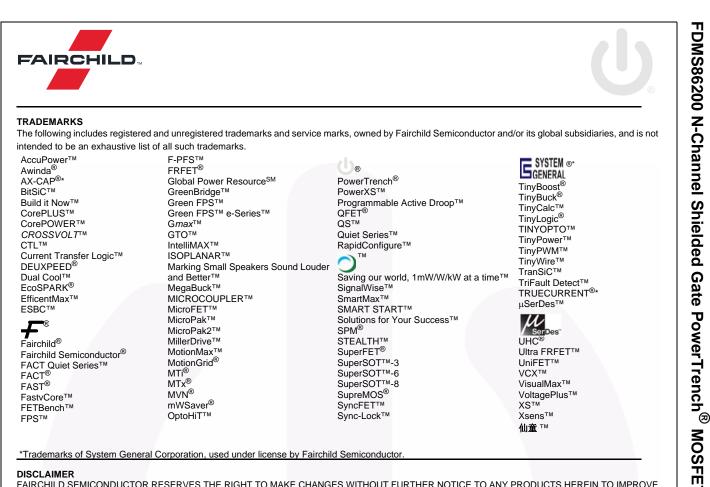
FDMS86200 N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET



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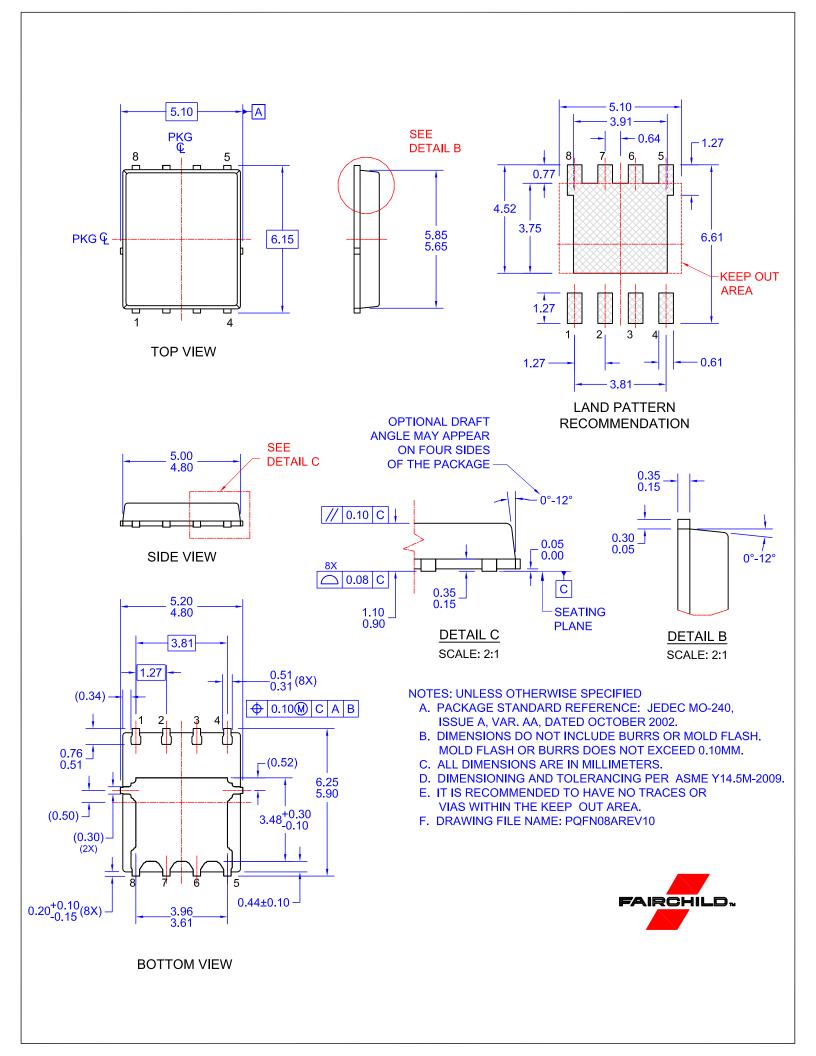
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